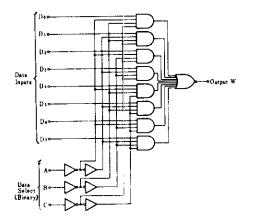
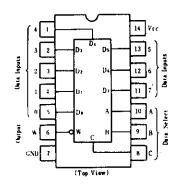
This data selector/multiplexer contains full-on-chip binary decoding to select the desired data source. The HD74LS152 selects one-of-eight data sources.

BLOCK DIAGRAM



PIN ARRANGEMENT



FUNCTION TABLE

Select inputs		Output Select inputs			uts	Output	
С	В	A	W	С	B	A	W
L	L	L	D ₀	н	L	L	D.
L	L	н	Dī	Н	L	Н	D ₅
Ĺ	Н	L	D ₂	н	н	L	D ₆
L	н	н	- D3	н	н	н	D ₇

Notes) $D_0 \sim D_7$; the level of the D respective input H; high level

L; low level

ELECTRICAL CHARACTERISTICS ($Ta = -20 \sim +75^{\circ}C$)

Item	Symbol	Test Conditions		min	typ*	max	Unit
<u> </u>	Vin			2.0	-	_	v
Input voltage	VIL			-	+	0.8	v
······································	Voн	Vcc=4.75V, Ion=-400µА, Vin=	=2V, VIL=0.8V	2.7		-	v
Output voltage	Vol	$V_{cc} = 4.75V, V_{IH} = 2V,$	IoL=4mA	-	-	0.4	v
		$V_{IL} = 0.8 V$	IoL=8mA	-	_	0.5	
	Іін	$V_{cc} = 5.25 V, V_l = 2.7 V$		-	_	20	μA
Input current	IL	$V_{cc} = 5.25 V, V_l = 0.4 V$		-	-	-0.4	mA
	Iı	$V_{\rm CC} = 5.25 \mathrm{V}, V_{\rm I} = 7 \mathrm{V}$		-	-	0.1	mA
Short-circuit output current	los	$V_{cc} = 5.25 \mathrm{V}$		- 20		-100	mA
Supply current **	Icc	$V_{CC} = 5.25 \mathrm{V}$		-	6.0	10	mA
Input clamp voltage	Vik	$V_{cc} = 4.75 V, I_{IN} = -18 m A$		_		-1.5	v

* V_{CC}=5V, Ta=25°C

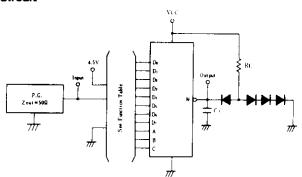
** I_{CC} is measured with all outputs open and all inputs at 4.5V.

SWITCHING CHARACTERISTICS ($V_{cc} = 5V$, $T_a = 25^{\circ}C$)

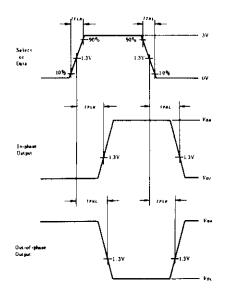
ltem	Symbol	Inputs	Outputs	Test Conditions	min	typ	max	Unit
	tplH	A, B, C	w	$C_L = 15 \mathrm{pF}, \ R_L = 2 \mathrm{k} \Omega$	-	14	23	
Propagation delay time	1PHL	A, D, C				20	32	
r ropagation delay time	1PLH	Data	w		-	13	21	ns
	tphi.	Data	¥¥ i		—	12	20	1 L

TESTING METHOD

1) Test Circuit



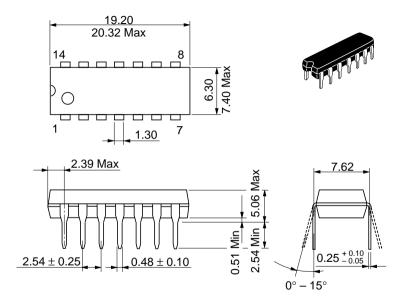
Waveform



- Notes) 1. Input pulse; *t_{TLH}*≤15ns, *t_{THL}*≤6ns, *PRR*=1MH2, duty cycle=50%

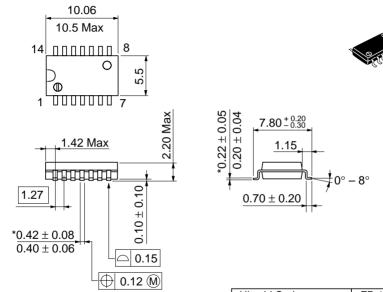
 - C_L includes probe and jig capacitance.
 All diodes are 1S2074 (H).

Unit: mm



Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g

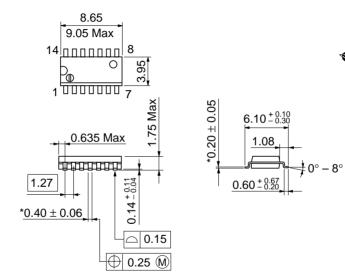
Unit: mm



*Dimension including the plating thickness Base material dimension

Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g

Unit: mm



Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g

*Pd plating

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